

	Type	L #	Hits	Search Text	DBs	Time Stamp
1	BRS	L1	126270 1	semiconductor	USPAT ; US-PG PUB; EPO; JPO; DERW ENT; IBM_T DB	2003/09/16 15:46
2	BRS	L2	353	438/108,109,123,617.ccls. and ((flip adj chip) same wire\$5)	USPAT ; US-PG PUB; EPO; JPO; DERW ENT; IBM_T DB	2003/09/16 15:48
3	BRS	L3	253	438/108,109,123,617.ccls. and ((flip adj chip) with wire\$5)	USPAT ; US-PG PUB; EPO; JPO; DERW ENT; IBM_T DB	2003/09/16 15:51
4	BRS	L4	269	438/108,109,123,617.ccls. and ((flip adj chip) with wire\$7)	USPAT ; US-PG PUB; EPO; JPO; DERW ENT; IBM_T DB	2003/09/16 15:55

	Comments	Error Definition	Errors
1			0
2			0
3			0
4			0

	Type	L #	Hits	Search Text	DBs	Time Stamp
5	BRS	L7	269	438/108,109,123,617.ccls. and ((flip adj chip) with (wire\$7 or (wire adj bond\$3)))	USPAT ; US-PG PUB; EPO; JPO; DERW ENT; IBM_T DB	2003/09/16 15:56
6	BRS	L6	195	4 and ((lead adj frame) or die)	USPAT ; US-PG PUB; EPO; JPO; DERW ENT; IBM_T DB	2003/09/16 16:01
7	BRS	L8	195	4 and ((lead adj frame) or die)	USPAT ; US-PG PUB; EPO; JPO; DERW ENT; IBM_T DB	2003/09/16 16:02

	Comments	Error Definition	Errors
5			0
6			0
7			0